Microelectronics Standards for DoD

FY20 NDAA Section 224

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Motivation & Introduction



NDAA: Standards

NDAA Language:

- b) Trusted Supply Chain and Operational Security Standards
- 1) Standards Required
 - A. Not later than January 1, 2021, the Secretary shall establish trusted supply chain and operational security standards for the purchase of microelectronics products and services by the Department.
 - B. For purposes of this section, a trusted supply chain and operational security standard
 - i. is a standard that systematizes best practices relevant to-
 - I. manufacturing location;
 - II. company ownership;
 - III. workforce composition;
 - IV. access to manufacturing data;
 - V. reliability of the supply chain; and
 - VI. other matters germane to supply chain and operational security; and
 - ii. is not a military standard ... that
 - I. specifies individual features for DoD microelectronics; or
 - II. otherwise inhibits the acquisition by the Department of securely manufactured, commercially available products.

Standards should address congressionally specified information but should not be military standards



NDAA: Consultation Required



b)(2) CONSULTATION REQUIRED.—In developing standards ..., the Secretary shall consult with the following:

- A. The Secretary of Homeland Security, the Secretary of State, the Secretary of Commerce, and the Director of the National Institute of Standards and Technology.
- B. Suppliers of microelectronics products and services from the United States and allies and partners of the United States.
- C. Representatives of major United States industry sectors that rely on a trusted supply chain and the operational security of microelectronics products and services.
- D. Representatives of the United States insurance industry

Workshop provides forum for representatives from all identified U.S. bodies to provide input



NDAA: Address Needs of USG and Commercial Industry

NDAA Language:

b)(4) The standards established ... shall be, to the greatest extent practicable, generally applicable to the trusted supply chain and operational security needs and use cases of the United States Government and commercial industry, such that the standards could be widely adopted by government agencies, commercial industry, and allies and partners of the United States as the basis for procuring microelectronics products and services.

Workshop Objective – Identify standards to support that are applicable to USG and industry



NDAA: Tiers of Trust, Annual Updates

NDAA Language:

b)(3) Tiers of Trust and Levels of Security Authorized — In carrying out paragraph (1), the Secretary may establish tiers and levels of trust and security within the supply chain and operational security standards for microelectronics products and services.

b)(5) Annual Review —Not later than October 1 of each year, the Secretary shall, in consultation with ... review the standards ... and issue updates or modifications as the Secretary considers necessary or appropriate.

Workshop: primary focus is baseline level of security Additional levels or tiers may be planned for annual updates



Definitions

Commercial	 A product, that is of a type customarily used by the general public or by nongovernmental entities for purposes other than governmental purposes, and has been sold, leased or licensed or offered for sale, lease or license to the general public A product that would satisfy a criterion expressed in paragraph (1) or (2) of this definition, except for- Modifications of a type customarily available in the commercial marketplace; or Minor modifications of a type not customarily available in the commercial marketplace made to meet Federal Government requirements. "Minor modifications" means modifications that do not significantly alter the nongovernmental function or essential physical characteristics of an item or component, or change the purpose of a process 	}r €
COTS Commercial off the Shelf	 Is a commercial product Sold in substantial quantities in the commercial marketplace; and Offered to Government without modification COTS are a subset of commercial products FAR 12.505 (summarized)	ed)
Hardware Assurance	An activity to ensure a level of confidence that microelectronics (also known as microcircuits, semiconductors, and integrated circuits, including its embedded software and/or intellectual property) function as intended and are free or known vulnerabilities, either intentionally or unintentionally designed or inserted as part of the system's hardware and/or its embedded software and/or intellectual property, throughout the life cycle.	of

DAU Glossary



Workshop Objectives

	1.	Recommend standards or sets of standards that
workshop 1	-	 a) provide commercially viable mitigations in support of FY20 NDAA Section 224 requirements
		 b) Provide coverage across all phases of the microelectronics development lifecycle c) Provide coverage across vendor types
	2.	Evaluate and improve candidate standards approach
		 Modular approach for integrated assured supply chain
		 Methods for determining and sharing compliance to standards across supply chain and to acquirer
		b) 224 related factors that influence sub-tier vendor selection
		 b) Requirements development and flow down
		c) Adoption strategy and timelines
		d) Organization of standards
Workshop 2	3.	Identify gaps between recommended standards and preferred or necessary supply chain practices
	4.	Develop path forward to address daps
		Workshop Objective – Recommend and organize standards



Microelectronics Standards – Section 224

LegendBLUER&E/CT DeliverableREDCommercial DocumentGREENOther DoD Documentation

DRIVER

 FY20 NDAA Sec 224 – "... shall establish trusted supply chain and operational security standards for the purchase of microelectronics products and services by the Department"

PLAN

- ANSI engagement to evaluate and populate DoD assurance framework with commercial standards across multiple categories
- DoD standards guidance identifies requirements to close any gaps between commercial standards and DoD assurance requirements
- · Leverages commercial standards to the extent practicable
- Annual updates







Approach: Risks, Vulnerabilities, Threats

The microelectronics standards approach utilizes CIA triad - Commonly used in networking / information security



Workshop Objective – Evaluate and Improve Standards Approach



Approach: Assumptions and Principles

- Workshop focus is COTS and commercial,
 - Choices made will have implications for DoD specific applications (e.g., CIC, FPGA)
- Leverage commercial best practices for baseline level of assurance for COTS and commercial parts
- Execution of DoD specific requirements should be limited to defense industrial base performers to the extent practicable.
- Standards should be
 - Implemented across the microelectronics lifecycle
 - Implemented across tiers of suppliers (commercial, Defense Industrial Base (DIB)) for DoD parts
 - Include a mechanism to assess compliance (e.g., compliance data package(s))
 - Technology agnostic
 - When necessary, multiple standards may be required to address breadth of parts (e.g., digital, analog, RF, radiation hardened, opto-electrical, etc.)

Commercial entities execute commercial standards; DoD unique requirements limited to DIB to extent possible



Q: Commercial vs. DoD Responsibilities

How does DoD envision this working across part types (e.g., COTS, commercial, FPGA, CIC)?

- The intent is that commercial entities execute commercial standards, while DoD unique requirements are limited to the DIB to the extent possible (see graphic)
 - In DoD parts that include both commercial and DoD unique elements (e.g., heterogeneous packages, SoC, etc.) functional decomposition is used



Commercial entities execute commercial standards; DoD unique requirements limited to DIB to extent possible



Identify & Organize Standards

WORKSHOP OBJECTIVE #1



Approach: Categorization of Mitigations

DoD has identified three supply chain practice areas to mitigate microelectronics supply chain risks

Risk Area	Description	Threat
Procurement Management	The process and contractual considerations required for evaluating and defining engagements with external entities for procurements; including the risks/mitigations identified from the other supply chain practice areas. Procurement processes are focused on mitigating risks associated with sourcing IP and parts (e.g., counterfeit, DMSMS), and should include considerations for vendor demographics as identified in FY20 NDAA Section 224 (e.g., company ownership, location, workforce composition)	C, I, A
Information and IP Protection	Risks attributed to the confidentiality of intellectual property and information not intended for public dissemination. May overlap with other supply chain practice areas. Processes are focused on mitigations associated with networks and personnel.	C , I
Secure Design	Design practices to improve assurance (e.g., verification and validation), manage risk when the part is outside vendor or user control, and address supply chain volatility (e.g., open architecture or modularity). May overlap with other supply chain practice areas.	C , I , A

Workshop Objective – Evaluate and Improve Standards Approach



Approach: Adopting and Establishing Standards



Workshop Objective – Recommend and organize standards



Q: How Many Standards?

How many standards will be adopted? Which ones?

- DoD is utilizing ANSI workshop to evaluate and populate DoD assurance approach with commercial standards across multiple categories.
 - Multiple standards could be identified to collectively address DoD needs
 - A single standard could support multiple DoD use cases (e.g., COTS, FPGA)
 - Etc.





Q: Microelectronics Lifecycle

LegendBLUEDoD / ProgramREDIndustryGRAYIndustry or DoD Contractor

Q: What do you mean by microelectronics lifecycle?		 The microelectronics development of the microelectronics development of the microelectronics development of the maintenance. Phases the shown in gray. Some phases This workshop is primarily focution. Recommended standard potentially integrated for the microelectronics development of the mic	ment lifecycle begins at requirements and ends at may be performed by commercial <i>or</i> DIB eler for DoD parts are performed by the DIB (blue). used on standards for COTS and Commercial F ds from this activity will be reviewed for applicat DoD specific applications (e.g., CIC, FPGA bit	at operations ments are Parts pility, and stream).
COTS / Commercial Development (not DoD)	COTS REQUIREMENTS Design	Verify Mask Wafer Fabrication Fabrication Note: May ha	Post-Si Validation / Test Ave "minor modifications" to COTS part for DoD reqts. (e.g., package reqts, screening reqts, etc.)	Post-Si ng Validation / Test
DoD Requirements (Part, System) Procure COTS Config./ prog. SW DoD COTS	Integrate and test and maint. Use	Design Verify Config./ PGA Design Verify Config./ prog. SW Integrate and test Operation and maint. FPGA	DoD Requirements (Part, System) Design Verify Mask Fabrication Wafer Fabrication Packaging Post-Si Validation / Test Custom Integrated Circuit (CIC)	Config./ Integrate Operation prog. SW and test and maint.



Frequently Asked Questions



Q :	Is Microelectronics Quantifiable Assurance (MQA) the same thing as the response to FY20 NDAA Section 224?	 No. MQA draft standards guidance was developed in response to FY20 NDAA Sec 224. However (a) extension to COTS and Commercial ME is needed, (b) ANSI engagement may identify commercial standards for use in CIC and FPGA to satisfy some DoD needs (e.g., design best practices, verification and validation, etc.)
CO		FPGA DRAFT I CIC DRAFT
Q :	Is a separate risk analysis required for all microelectronic parts in my DoD system?	 This is program and requirements dependent COTS and commercial parts. The 224 standards are intended to represent a baseline level of assurance for these components. The underlying analysis is considered during establishment of the standards (i.e., now) and updated annually by DoD.
Q :	What about FY21 NDAA Section 841? (Printed Circuit Boards (PCBs))	 PCB Executive Agent is responsible for response to Congress PCB Executive Agent working towards update of IPC 1791 to satisfy NDAA requirement Overall standards approach is process oriented and expected to be able to support PCB response and standard(s)
Q :	Are 224 standards applied to all microelectronics components	• Yes



Evaluate and Improve Candidate Standards Approach

WORKSHOP OBJECTIVE #2



Risk Management and Requirements Development

	Risk Analysis Task	Status	Notes	
1	Determine Applicability	Complete	Focus: COTS and commercial Technology agnostic	
2	Analysis	Workshop Activity	DoD responsibility	
2a	Risk analysis – identify risks, vulnerabilities, threats	Complete	Utilize CIA triad	
2b	Risk management – select, apply mitigations	Workshop Activity	DoD responsibility. Workshop solutions	
2c	Evaluation – assess residual risk	Workshop Activity	unique or commercial expectations)	
3	Execution	N1/A	Outside the scope of the workshop Completed per design, part, program	
3a	Demonstrate compliance			

Workshop Objective – Recommend and organize standards



Q: Commercial vs. DoD Requirements



How does a commercial standards approach align to DoD specific requirements?

- DoD guidance will include both use of commercial standards and DoD specific requirements (intended for DIB)
 - 1. This workshop is focused on identifying appropriate standards
 - Satisfy FY20 NDAA Sec 224, address microelectronics assurance
 - 2. This workshop provides preliminary identification of gaps to DoD needs
 - Workshop 2 (Oct 2022) develops plans to close those gaps



Commercial entities execute commercial standards; DoD unique requirements limited to DIB to extent possible



Responsibility: Requirements, Risk Analysis

			Responsibility for	Responsibility for	
	Reqt Received	Risk Analysis	Reqt Development	Reqt Flow Down	
DoD	FY20 NDAA Sec 224	Updated annually (FY20 NDAA Sec 224)	 Primary responsibility Consulting with USG, industry, SDOs (including ANSI workshop) 	TBD. For consideration:Program requirementsDoD policy / guidanceDFARS update	
Program (or primary acquirer)	TBD. For consideration:Program requirementsDoD policy / guidanceDFARS update	 Per DoDI 5200.44, 5000.83 Separate analysis is not expected for each COTS part 	 Execute 224 contracts requirements, including flow down; and Supplement 224 contracts requirements in accordance with program risk analysis 	 Flow down 224 contracts requirements and any relevant supplemental requirements 	
Performers	 224 contracts requirements and any relevant supplemental requirements received from next-higher acquiring entity 	 Performer may perform additional risk analysis to tailor (supplement) requirements for themselves and/or flow down 	 Execute 224 contracts requirements including flow down; and Performer may tailor (supplement) 224 contracts requirements 	 Flow down 224 contracts requirements as required; and Performer may flow down supplemental requirements 	
Workshop Objective – evaluate and improve candidate approach					
Performers should flow down 224 requirements and may add vendor or product specific assurance requirements					
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Modular Implementation



- Application of standards is intended to be modular
- Interlocked supply chain practices, when utilized across tiers of performers culminate in an integrated assured supply chain
- Evidence of compliance is passed through the supply chain

Workshop objective – Recommend acceptance criteria for compliance

Interlocked application of 224 standards yields integrates assured supply chain



Q: How is Approach Integrated Across Lifecycle

Q: How is the modula utilized across the	r approach supply chain (repe	 Acquirer flows down requirements (e.g., 224 standards) and considers vendor demographics for assured microelectronics Performers execute standards, provide compliance data packages to their customer (repeats across tiers of vendors) 		
3PIP: Thi	rd Party Intellectual Property	KTR: Contractor	Post-Si: Post Silicon	
Baseline requirements flowed down to performers across the lifecycle	Design	ify Mask Wafer Fabrication Fabrication	Post-Si Packaging Validation / Test Prog. SW and t	rate Operation test and maint.
Multiple vendors may support a single lifecycle phase	Dod KTR	3PIP #1 3PIP #n	DoD KTR Verification IP	DoD KTR
Each vendor applies appropriate standards to its activities	Perfo Evidence of Compliance S S	rmer Supplier sk Management ocurement formation, IP Protection upply Chain Traceability ccure Design	Evidence of Compliance - Risk Mana - Procureme - Information - Supply Cha - Secure Des	gement int n, IP Protection in Traceability sign

Interlocked application of 224 standards yields integrates assured supply chain



224 Standards – Influencing Vendor Selection

- Assurance factors in selecting microelectronics products and service providers:
 - Vendor Demographics
 - Application of 224 standards
 - Availability of compliance information for 224 standards
 - Supply chain illumination and awareness
 - Tailored risks, mitigations, standards

Required by FY20 NDAA Sec 224

• DoD programs should consider non-compliance to 224 standards in their evaluation of technical risk.

Workshop Objective – evaluate and improve candidate approach



Q: What are the Expectations for Adoption?

TODAY: SCRM and counterfeit policies and regulations provide a baseline to ensure authenticity of DoD microelectronics and to ensure health and security of suppliers. DoD standards approach seeks to extend assurance via application of standards.



GOAL: Integrated assured supply chain, with all tiers of suppliers from design utilizing 224 standards.

INTERIM: What is the expectation for adoption rate? What are the challenges to rapid adoption? What could be done to overcome those challenges?

Workshop Objective – Recommend adoption strategy



Breakout: Microelectronics Standards Evaluation

- 1. Recommend standards or sets of standards that
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- 2. Evaluate and improve candidate standards approach
 - a) Modular approach for integrated assured supply chain
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 - b) 224 related factors that influence sub-tier vendor selection
 - b) Requirements development and flow down
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Workshop Objective – Recommend and organize standards Workshop objective – evaluate and improve candidate approach